

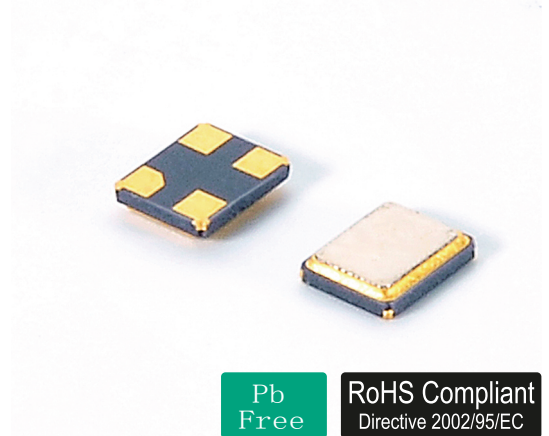
3.2x2.5 SMD Crystal

FEATURE

- Rugged AT-cut crystal construction.
- Miniature 3.2×2.5mm ceramic package.
- Designed for automatic mounting and reflow soldering.
- Embossed tapping specification.
- Pb-free and RoHS/Green compliant.

APPLICATIONS

- Ideally suited designed for Bluetooth wireless communication sets, HDD, DSN, PDA, GPS, Digital Tuner, Wireless LAN and mobile phone.



Pb Free

RoHS Compliant
Directive 2002/95/EC

Electrical Specifications 电气参数

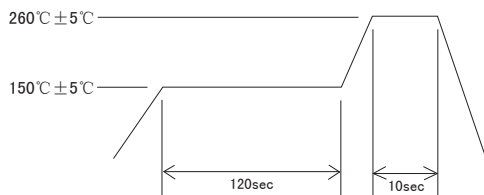
型号	Holder Type	3.2x2.5mm Ceramic Surface Mount
频率范围	Frequency Range	12MHz to 54MHz
调整频差	Frequency Tolerance (ΔF) (at 25°C)	± 10 ppm to ± 30 ppm
温度频差	Frequency Drift	± 10 ppm to ± 30 ppm*(See Notes)
工作温度范围	Operating Temperature Range	-20°C - +70°C / -40°C - +85°C
储存温度范围	Storage Temperature Range	-40°C - +85°C / -55°C - +125°C
老化	Aging (25°C)	± 3 ppm/ year max.
静电容	Shunt Capacitance (C0)	3pF max.
激励功率	Drive Level	10 μ w (100 μ W max.)
绝缘阻抗	Insulation Resistance (Rs)	500 Megaohms Minimum at D.C100V
负载电容	Load Capacitance (CL)	Suggested by customer

※Notes: ± 10 , ± 20 , ± 30 ppm (-20°C to +70°C)
 ± 20 , ± 30 , ± 50 ppm (-40°C to +85°C) or depends on customer

Equivalent Series Resistance and Mode of Operation 等效阻抗和振荡模式

Frequency Range 频率范围	ESR () 等效阻抗	Mode 振荡模式
12.000MHz ≤ f < 16.000MHz	100 Ω max	Fundamental
16.000MHz ≤ f < 20.000MHz	80 Ω max	Fundamental
20.000MHz ≤ f < 24.000MHz	60 Ω max	Fundamental
24.000MHz ≤ f < 54.000MHz	40 Ω max	Fundamental

Reflow Condition(回流焊条件)



CYCLE TIME: 200sec Max.

Mechanical Dimensions 外型尺寸

